

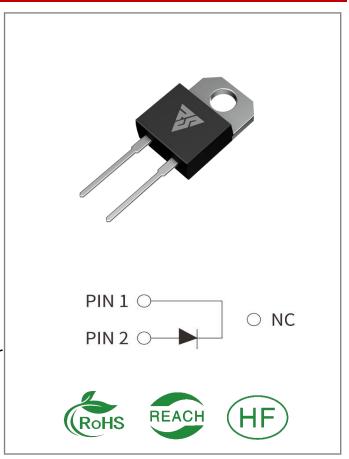
VRRM	IF (TC≤150°C)	QC	
650V	6A	23nC	

Applications:

- Power Factor Correction
- Sever Mode Power Supplies
- Uninterruptible Power Supply

Features:

- Low Forward Voltage Drop
- High-Speed Switching
- Positive Temperature Coefficient
- Temperature-Independent Switching Behavior



Ordering Information

Part Number	Package	Marking	Packing	Qty.
RSS06065B	TO-220-2 内绝缘	RSS06065B	Tube	50 PCS



Maximum Ratings (TJ= 25°C unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
VRRM	Repetitive Peak Reverse Voltage	650	V		
VRSM	Surge Peak Reverse Voltage	650	V		
VR	DC Blocking Voltage	650	V		
IF	Forward Current	6	Α	TC ≤ 150℃	
IFSM	Non-Repetitive Forward Surge Current	50	Α	TC = 25°C, tp = 10ms Half Sine Wave	
IF,Max	Non-Repetitive Peak Forward Surge Current	520	Α	TC=25°C, tP= 10 μs, Pulse	
IFRM	Repetitive Peak Forward Surge Current	35	А	TC = 25° C, tp = 10 ms Half Sine Wave	
Ptot	Power Dissipation	70 W		TC = 25°C TC = 110°C	
TJ,TST G	Operating Junction and Storage Temperature	-55 to175	\mathbb{C}		

Electrical Characteristics (TJ= 25°C unless otherwise specified)

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
VF	Forward Voltage	1.4 1.6	1.6 1.8	٧	IF =6A, TJ = 25°C IF =6A, TJ = 175°C	
IR	Reverse Current	2 15	30 120	μΑ	VR =650V, TJ = 25°C VR = 650V, TJ = 175°C	
С	Total Capacitance	423 44 37	/	pF	VR=0V, TJ = 25° C, f=1MHz VR=200V, TJ = 25° C, f=1MHz VR=400V, TJ = 25° C, f = 1MHz	
QC	Total Capacitive Charge	23	/	nC	$VR = 400V, TJ = 25^{\circ}C$ $Qc = \int_{0}^{V_{R}} C(V) dV$	

Thermal Characteristics (TJ= 25°C unless otherwise specified)

Symbo	Parameter	Тур.	Unit	Note
RθJC	Thermal Resistance from Junction to Case	2.3	°C/W	



Typical Feature Curve

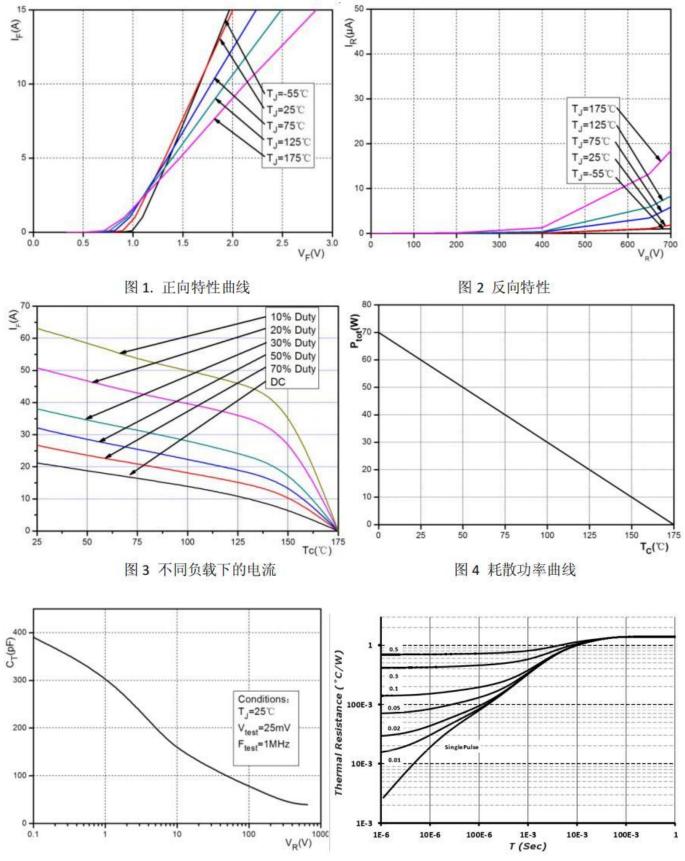


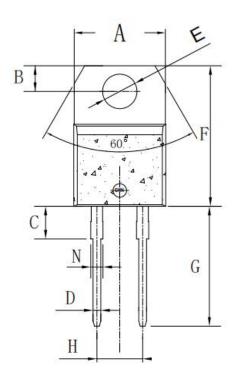
图 5 电容一反向电压曲线

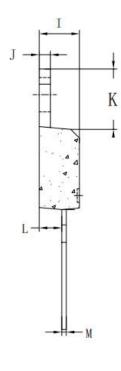
图 6 结到壳热阻曲线



Package outline drawing(TO-220 Unit: mm)

PACKAGE OUTLINE DIMENSIONS TO-220A-2L





DIM	Unit(r	nm)	Unit(inch)		
DIM.	Min	Max	Min	Max	
Α	9.8	10. 4	0. 385	0. 409	
В	2. 65	3. 1	0. 104	0. 122	
C	2.8	4. 2	0.110	0. 165	
D	0.7	0. 92	0. 027	0.036	
Е	3. 75	3.95	0. 147	0. 155	
F	14. 8	16. 1	0. 582	0.633	
G	13. 05	13. 6	0. 513	0.535	
Н	4. 9	5. 3	0. 192	0. 208	
1	4. 38	4.61	0. 172	0. 181	
J	1. 15	1. 36	0.045	0.053	
K	5. 85	6.82	0.230	0. 268	
L	2. 35	2.75	0.092	0. 108	
М	0. 35	0.65	0. 013	0. 025	
N	1. 18	1. 42	0.046	0. 055	



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